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10/743,113	12/22/2003	Kyung Yun Jung	SUN-DA-114T	8491	
	557 7590 12/29/2008 ALIWANCHIK LLOYD & SALIWANCHIK			EXAMINER	
A PROFESSIONAL ASSOCIATION PO BOX 142950 GAINESVILLE, FL 32614-2950			MONDT, JOHANNES P		
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)
	10/743,113	JUNG, KYUNG YUN
Office Action Summary	Examiner	Art Unit
	JOHANNES P. MONDT	3663
The MAILING DATE of this communication ap Period for Reply	ppears on the cover sheet with the	correspondence address
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING ID. - Extensions of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period. - Failure to reply within the set or extended period for reply will, by stature Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICATIO .136(a). In no event, however, may a reply be tind d will apply and will expire SIX (6) MONTHS from te, cause the application to become ABANDONE	N. mely filed the mailing date of this communication. ED (35 U.S.C. § 133).
Status		
Responsive to communication(s) filed on <u>24 S</u> This action is FINAL . 2b) ☐ This action is FINAL . Since this application is in condition for allowed closed in accordance with the practice under	is action is non-final. ance except for formal matters, pr	
Disposition of Claims		
4) Claim(s) 1-10 is/are pending in the application 4a) Of the above claim(s) is/are withdra 5) Claim(s) is/are allowed. 6) Claim(s) 1-10 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/ Application Papers	awn from consideration.	
9) The specification is objected to by the Examin 10) The drawing(s) filed on is/are: a) ac Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E	cepted or b) objected to by the edrawing(s) be held in abeyance. Section is required if the drawing(s) is ob	e 37 CFR 1.85(a). ojected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for foreig a) All b) Some * c) None of: 1. Certified copies of the priority documer 2. Certified copies of the priority documer 3. Copies of the certified copies of the priority application from the International Burea * See the attached detailed Office action for a list	nts have been received. nts have been received in Applicat ority documents have been receiv au (PCT Rule 17.2(a)).	ion No ed in this National Stage
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal I 6) Other:	ate

Art Unit: 3663

DETAILED ACTION

Response to Amendment

1. Remarks filed 9/24/08 in response to the Office action mailed 6/25/08 form the basis for this Office action. Comments on Remarks are included below under "Response to Arguments".

Response to Arguments

- 2. Applicant's arguments filed 9/24/08 have been fully considered but they are not fully persuasive.
- 3. (a) Applicant's first argument is that by "forming a gate electrode pattern on an isolation region, there is no channel region that could be considered a lower electrode to which a first contact plug is connected". See page 2.

Examiner disagrees: isolation region 11 is only optional: see [0021]; even arguendo, only a portion of said gate electrode pattern is formed on isolation region 11, none of it directly on it, while another portion is formed directly on semiconductor substrate 10 thus forming a channel in the ON state. See Drawing 13 (a). Said channel is electrically connected to contact plug 23 through poly-plug 17. Parenthetically, examiner cannot find any reference to 13a in his rejection; presumably, applicant meant "13".

(b) Applicant's second argument is that a protective layer on the gate electrode prevents electrical contact with plug 23a.

Examiner agrees that what was advertised to be the "full text" of the computerized translation may indicate that the gate electrode is 13 and not 14 counter

Application/Control Number: 10/743,113

Art Unit: 3663

to what is spelled out specifically in the Description of the Drawings, missing in said "full text" and to which reference is made. See item U on PTO-892 enclosed with this Office Action for "Description of the Drawings". Examiner regrets to have overlooked its absence in said "full text". From said "full text" the protective layer 14 is disclosed by example to be a SiN layer, which is an insulator. Depending on thickness and comprehensive coverage an electrical connection between gate (upper electrode) 13 and plug 23a exists or not. A full manual translation of Fukuzumi has been ordered from the Translator Branch at the United States Patent and Trademark Office so as to resolve the clear inconsistencies in the different parts of the translation. However, pending said manual translation the rejection over Fukuzumi is maintained and included in this action by reference, while an alternative rejection is being provided herewith based on the observation that the gate electrode as disclosed by Fukuzumi is connected to a word line, while the prior art renders obvious the routing of said word line through an overlying insulating layer. Indeed, as specifically taught by Lee et al (US 2001/0005604 A1) in art on a fuse area structure in a semiconductor device, hence

Page 3

The rejections provided with this Office action are based on the above considerations.

analogous art, "the word line can be used as the fuse line" (see [0008] and [0047]; and

see prior art Figure 1 and see Figure 8). A comparison between the actual invention by

Lee et al and the alternative so suggested renders the claimed invention obvious.

Art Unit: 3663

Claim Rejections - 35 USC § 103

4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 5. Claims 1-10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Cloud et al (US 2002/0015322 A1) in view of Lee et al (US 2001/0005604 A1) and Noble et al (US 2002/0024083 A1).

Cloud et al teach a semiconductor device (see Abstract), comprising:

a capacitor having a bottom electrode (channel of MOSFET 210) ([0030]), a dielectric layer 213 formed on the bottom electrode, and an upper electrode (gate electrode 212 of MOSFET 210) formed on the dielectric layer, the capacitor being formed on a semiconductor substrate 211([0029]) (see Figure 2);

a first insulating layer 232 formed on the semiconductor substrate covering the capacitor;

while Cloud et al do no specifically disclose the limitation of lines 6-11 of claim 1 but instead omit details on the bitline connections altogether, it would have been obvious to include said limitation in view of Lee et al, who, in a patent application drawn

to a DRAM device (see title, abstract and "Background of the Invention"), hence art analogous to Cloud et al, teach:

a plurality of contact plugs 122, 128 formed in a plurality of via holes of the first insulating layer 120, each electrically connected to either the bottom electrode (channel of semiconductor substrate 110 (semiconductive because otherwise the gate action of 114 would not be operative in the transistor) or the upper electrode (age electrode 114), namely: electrically connected to the bottom electrode (through the source/drain regions 116 and 118) (see Figure 8; also see Figures 1 and 9-10);

a first metal wiring 124 (bitline wiring) formed on the first insulating layer 120 and connected to the bottom electrode through one of the first contact plugs (122);

a second insulating layer (either 126 or 126/136) formed on the first insulating layer.

(End of reference to teaching by Lee et al).

As shown by Lee et al, the inclusion of the limitation is nothing more than the application of standard, i.e., conventional DRAM device design employing a multi-layer metal interconnection structure (see also Figure 1 in their description of the Prior Art at the time of their filing, which also exhibits the same DRAM bitline design). The limitation is especially obvious in light of the conventional multi-layer construction of DRAM devices (see [00006]] in Lee et al) wherein examiner takes official notice that for reason of separate operating function different metal connections are separated by interlayer dielectric.

Furthermore, Cloud et al teach:

a second contact plug 230 in insulating layer 232 ([0030]) and connected to the upper electrode 212;

an anti-fuse (capacitor dielectric 222) ([0030]) [Examiner note: anti-fuse materially is nothing more than a thin dielectric layer, "anti-fuse" distinguishing only intended use] formed on the second contact plug in a second via hole, i.e., via hole in a "subsequent layer" containing capacitor 220, which would have been obviously insulating within the context of aforementioned multi-layered DRAM design; said antifuse or capacitor dielectric capable of providing electrical connection of a third contact plug to the second contact plug (see below for an embodiment thereof; however, it is noted that the limitation "for electrical connection to the second contact plug" constitutes only a limitation of intended use); the third contact plug here being the concave central portion of top plate 223, filling the second via hole and formed within the anti-fuse, wherein the third contact plug does not directly contact any underlying insulating layer other than said anti-fuse; and

a second metal wiring (top and side portions of top plate 213) formed on the insulating layer 232 and electrically connected to the third contact plug (through a contiguous connection) and to the anti-fuse (which it abuts and hence exerts capacitive coupling thereon).

Cloud et al do not specifically teach the limitation that the second contact plug is formed in a second insulating layer because as we have seen Cloud et al only provide an incomplete teaching of the bitline interconnect. However, following the teaching of Lee et al as referred to above, it would have been obvious to locate the capacitor well

Art Unit: 3663

above and separated by interlayer dielectric from the bit lines, motivation being provided by said separation of functionally independent metal parts: this is what Lee et al disclose: capacitor 130/132/134 connected to contact plug (upper portion of 128) in a second insulating layer 126 on a first insulating layer 120. The limitation would have been obvious nothing more than the application of standard, i.e., conventional DRAM device design employing a multi-layer metal interconnection structure (see also Figure 1 in their description of the Prior Art at the time of their filing, which also exhibits the same DRAM bitline design). The limitation is especially obvious in light of the conventional multi-layer construction of DRAM devices (see [00006]] in Lee et al) wherein examiner takes official notice that for reason of separate operating function different metal connections are separated by interlayer dielectric. Incorporation of the teaching by Lee et al in the semiconductor device by Cloud et al requires nothing more than combining prior art elements according to known methods to yield predictable results: the additional teaching by Lee et al only ensures placing bitline metal on a lower interlayer dielectric than the capacitor. In the invention by Cloud et al the capacitor is placed on the gate of the transistor and hence both source and drain interconnects could connect at a comparable, and lower interlayer dielectric level than the level of the capacitor, as confirmed by Noble et al (US 2002/0024083 A1) (see source line 217A and bit line 219A in vertical relation to the capacitor 220; Figure 2 and [0047]-[0049]).

On claim 2: first and second metal wiring are perpendicular to each other (word line WL and bitline BL; see Fig. 1; wordline is tied to second wiring (top plate 223) (Figure 2 and [0011]) (see also Noble et al; Figure 2 and [0047]-[0049]).

On claims 3 and 8: The device of claim 1 would necessarily have to be formed in order to function. Claim 1 fails to further limit the device of claim 1 other than simply form each of their components.

On claim 5: in the combined invention, wherein the interlayer dielectrics are taken from Lee et al, the upper surface of the third contact plug and the upper surface of the second insulating layer are at least substantially in the same horizontal plane; namely: the upper plane boundary, on the right-hand side, of 126/136 (see Figures 8-10). Applicant does not disclose the specific equality of heights, implicitly an extremely narrow range limitation, to be critical to the invention. Its incorporation in a dependent claim only is evidence to the contrary. Applicant's disclosure does not teach why the range as claimed is critical to the invention. In view of the absence of a teaching why a range is critical to the invention. Applicant is reminded that it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or working ranges involves only routine skill in the art. In re Aller, 105 USPQ 233.

On claims 4 and 7: in the combined invention, the anti-fuse 222 is formed between the second contact plug 230 and the third contact plug (inner, central portion of 223) and between the second insulating layer (which, following Lee et al takes up the uppermost portion of 232) and the third contact plug (inner central portion of 223 between the vertical parts of 222).

On claims 6 and 10: the range limitation on relative width of the third contact plug to that of the second contact plug recited by claim 6 has not been disclosed as critical to applicant's invention. On the contrary, said range limitation evidently is not critical to the

Art Unit: 3663

invention, because claim 1 defines an acceptable invention by applicant and does not contain the limitation of said range. Applicant is reminded that Applicant's disclosure does not teach why the range as claimed is critical to the invention. In view of the absence of a teaching why a range is critical to the invention Applicant is reminded that it has been held that where the general conditions of a claim are disclosed in the prior art, discovering the optimum or working ranges involves only routine skill in the art. In re Aller, 105 USPQ 233.

Conclusion

6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Lee et al (US 6,861,686 B1) (previously so cited).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to JOHANNES P. MONDT whose telephone number is (571)272-1919. The examiner can normally be reached on 7:30 - 17:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Jack W. Keith can be reached on 571-272-6878. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Art Unit: 3663

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/Johannes P Mondt/ Primary Examiner, Art Unit 3663